



MATERIAL
 INSULATOR: HI-TEMP PPS UL 94V-0, 240°C
 CONTACT: COPPER ALLOY.
 PLATING: MATING AREA - GOLD FLASH GOLD OVER NICKEL.
 SOLDER AREA - TIN OVER NICKEL.

ELECTRICAL
 VOLTAGE RATING: 250 VAC RMS.
 CURRENT RATING: 1 AMP.
 DIELECTRIC WITHSTANDING VOLTAGE: 500 VAC RMS 60Hz FOR 1 MINUTE.
 INSULATION RESISTANCE: 1000 MEGOHMS MIN AT 500 VDC.
 CONTACT RESISTANCE: 30 MILLIOHMS MAX.

MECHANICAL
 RETENTION FORCE: 460 GRAMS MIN PER CONTACT.
 INSERTION FORCE: 230 GRAMS MAX PER CONTACT PAIR.
 WITHDRAWAL FORCE: 15 GRAMS MIN PER CONTACT PAIR.

ENVIRONMENTAL
 TEMPERATURE RANGE: -55°C TO +85°C.
 P.C.BOARD THICKNESS: 1.2MM-1.6MM

HE-VZ-xxx-LF
 LEADFREE
 004~182WAY
 RoHS Compliant

Circuit	Dimension			Circuit	Dimension		
	A	B	C		A	B	C
04	8.64	3.81	1.27	38	30.23	25.40	22.86
06	9.91	5.08	2.54	40	31.50	26.67	24.13
08	11.18	6.35	3.81	42	32.77	27.94	25.40
10	12.45	7.62	5.08	44	34.04	29.21	26.67
12	13.72	8.89	6.35	46	35.31	30.48	27.94
14	14.99	10.16	7.62	48	36.58	31.75	29.21
16	16.26	11.43	8.89	50	37.85	33.02	30.48
18	17.53	12.70	10.16	52	39.12	34.29	31.75
20	18.80	13.97	11.43	54	40.39	35.56	33.02
22	20.07	15.24	12.70	56	41.66	36.83	34.29
24	21.34	16.51	13.97	58	42.93	38.10	35.56
26	22.61	17.78	15.24	60	44.20	39.37	36.83
28	23.88	19.05	16.51	80	56.90	52.07	49.53
30	25.15	20.32	17.78	100	69.60	64.77	62.23
32	26.42	21.59	19.05	120	82.30	77.47	74.93
34	27.69	22.86	20.32	160	95.00	90.17	87.63
36	28.96	24.13	21.59	182	121.67	116.84	114.30

	PART NO. HE-VZ-xxx		CHECKED BY CY	TOLERANCES ARE .X ± 0.2 .XX ± .XXX ± AWG	DESCRIPTION: 1.27 PITCH CARD EDGE SMT			
	DWG NO. HE-VZ-xxx				DRAWING BY	AREA	REVISIONS	HK
	FILE NO.		PROJECTION					
	UNIT / mm	SCALE 1:1						